[Translation]
NOTICE: The following report is an English Translation of the Japanese-language original.
This press release is made pursuant to the requirements under the listing rules of, and reported to, the Tokyo Stock Exchange.

August 8, 2017

To whom it may concern,

Company name: SUMCO Corporation
Representative: Mayuki Hashimoto, Representative Director
Chairman & Chief Executive Officer
(Code: 3436, TSE First Section)
Contact: Hiroshi Shibuya, General Manager
Public Relations & IR Department
(Tel:+81-3-5444-3915)

Notice Regarding Capital Investment (Acquisition of Fixed Assets)

Please be informed that SUMCO Corporation resolved to implement capital investment as described below at a meeting of the board of directors held today.

1. Reason for the Capital Investment

300mm silicon wafers market is expected to grow. The biggest demand increase is from leading-edge wafers; since suppliers able to supply these are limited, the demand-and-supply situation is expected to be tighter. In response to these circumstances, we have decided to invest, from our own cash, in a capacity expansion by 110,000 wafers a month, aiming for the first half of 2019. This decision is premised on long-term sales contracts with customers, and is in line with our responsibility as a supplier of 300mm leading-edge wafers.

2. Details of the Capital Investment

a)	Asset Name	300mm silicon wafer production equipment
b)	Location	Imari City, Saga Prefecture
c)	Projected investment amount	¥43.6 billion
d)	Funds procurement method	Own cash

3. Scheduled Start of Operations

First half of 2019

4. Future Outlook

This capital investment will have no effect on the Company’s current term business performance.